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March 2015

# FAN6100M Secondary-Side Constant Voltage and Constant Current Controller Compatible with MediaTek Pump Express<sup>™</sup> Plus

#### **Features**

- Supports MediaTek Pump Express<sup>TM</sup> Plus and Fairchild's FCP-Single communication protocol Specifications
- Secondary-Side Constant Voltage (CV) and Constant Current (CC) Regulation
- Built-in Charge-Pump Circuit for Low Output Voltage Operation
- Internal, Accurate, Adaptive CV/CC Reference Voltage
- Low-Value Current Sensing Resistor for High Efficiency
- Programmable Cable Voltage Drop Compensation
- Two Operational Transconductance Amplifiers with Open-Drain Type for Dual-Loop CV/CC Control
- Compatible with Fairchild's FAN501A
- Adaptive Secondary-Side Output Over-Voltage Protection through Photo-Coupler
- Output Under-Voltage Protection
- Low Quiescent Current Consumption in Green Mode < 850 µA</p>
- Wide VIN Supply Voltage Range
- Available in 20-Pin 3 x 4 mm MLP Package

#### **Applications**

- Battery Chargers for quick charge application
- AC/DC Adapters for Portable Devices that Require CV/CC Control

### Description

The FAN6100M is a highly integrated secondary side constant voltage and constant current controller that is compatible with MediaTek Pump ExpressTM Plus and Fairchild's FCP-Single communication protocol specifications. It is designed for use in application that requires Constant Voltage (CV) and Constant Current (CC) regulation.

The controller consists of two operational amplifiers for voltage and current loop regulation with adjustable reference voltage. The CC control loop also incorporates a current sense amplifier with gain of 10. Outputs of the CV and CC amplifiers are tied together in open drain configuration.

The FAN6100M enables power adaptor's output voltage adjustment if it detects a protocol capable powered device. It can be capable of outputting 5 V at the beginning, and then 7 V, 9 V or 12 V to meet requirements of a high voltage dedicated charging port (HVDCP) power supply or 4.8 V, 4.6 V, 4.4 V, 4.2 V or 4 V to maximize the charging current which is controlled by the power adaptor. If a non compliant powered device is detected, the controller disables output voltage adjustment to ensure safe operation with smart phones and tablets that support only 5 V.

FAN6100M also incorporates an internal charge pump circuit to maintain CC regulation down to the power supply's output voltage, Vbus of 2 V without an external voltage supply to the IC. Programmable cable voltage drop compensation allows precise CV regulation at end of USB cable via adjusting one external resistor.

The device is available in the 20-pin MLP  $3 \times 4$  package.

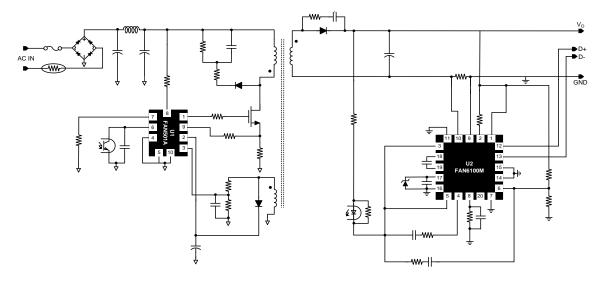
# MediaTek Pump Express™

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### **Ordering Information**

Part Number	Operating Temperature Range	Package	Packing Method
FAN6100MMPX	-40°C to +125°C	20-Lead, MLP, QUAD, JEDEC MO-220, 3 mm x 4 mm, 0.5 mm Pitch, Single DAP	Tape & Reel

## **Application Diagram**



**Figure 1. Typical Application** 

# **Internal Block Diagram**

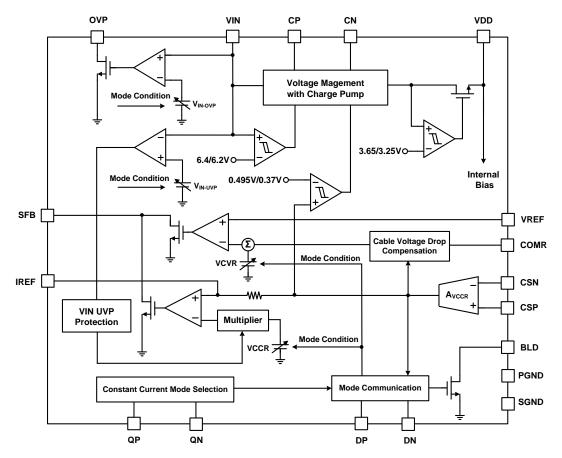
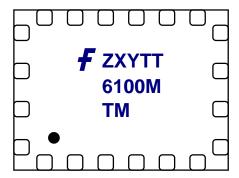


Figure 2. Function Block Diagram

# **Marking Information**



F- Fairchild Logo

Z: Assembly Plant Code

X: Year Code Y: Week Code TT: Die Run Code

T: Package Type (MP=MLP)
M: Manufacture Flow Code

Figure 3.Top Mark

# **Pin Configuration**

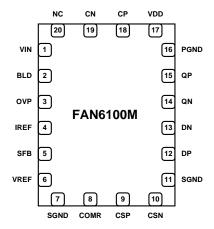


Figure 4. Pin Assignments

### **Pin Definitions**

3	VIN BLD OVP IREF	Input Voltage Detection. This pin is tied to output terminal of the power adaptor to monitor output voltage and supply internal charge pump circuit.  Output Bleeder Current Setting. This pin connects to output terminal of the power adaptor via an external resistor to form an output discharging path when mode changes from high-output voltage to low-output voltage.  Output Over-Voltage-Protection. This pin is used for adaptive output over-voltage protection. Typically an opto-coupler is connected to this pin to generate pull-low protection signal.  Reference Output Current Sensing Voltage. The voltage is the amplifying output current sensing
3 (	OVP	external resistor to form an output discharging path when mode changes from high-output voltage to low-output voltage.  Output Over-Voltage-Protection. This pin is used for adaptive output over-voltage protection. Typically an opto-coupler is connected to this pin to generate pull-low protection signal.
		Typically an opto-coupler is connected to this pin to generate pull-low protection signal.
4 I	IREF	Reference Output Current Sensing Voltage. The voltage is the amplifying output current sensing.
		voltage. This pin is tied to the internal CC loop amplifier positive terminal.
5	SFB	Secondary-Side Feedback Signal. Common output terminal of the dual operational transconductance amplifiers with open drain operation. Typically an opto-coupler is connected to this pin to provide feedback signal to the primary-side PWM controller.
6 V	VREF	Reference Output Voltage Sensing Voltage. This pin is used to sense the output voltage for CV regulation via resistor divider. It is tied to the internal CV loop amplifier positive terminal.
7 S	SGND	Signal Ground.
8 C	COMR	Programmable Cable-Drop Voltage Compensation. An external resistor is connected to this pin to adjust output voltage compensation weighting.
9	CSP	Positive Terminal of Output Current Sensing Amplifier. This pin connects directly to the positive voltage terminal of the current sense resistor. CSP need to be tied to ground of power adaptor via short PCB trace.
10	CSN	Negative Terminal of Output Current Sensing Amplifier. This pin connects directly to the negative voltage terminal of the current sense resistor. CSN need to be tied to negative terminal of output capacitor via short PCB trace.
11 S	SGND	Signal Ground.
12	DP	Positive Terminal of Communication Interface. This pin is tied to the USB D+ data line input.
13	DN	Negative Terminal of Communication Interface. This pin is tied to the USB D- data line input.
14	QN	LSB Switch for Mode Selection of Output Current.
15	QP	MSB Switch for Mode Selection of Output Current.
16 P	PGND	Power Ground.
17	VDD	Power Supply. IC operating current is supplied through this pin. This pin is typically connected to an external VDD capacitor.
18	СР	Positive Voltage Terminal of Charge Pump.
19	CN	Negative Voltage Terminal of Charge Pump. An external capacitor is necessary to be connected between CP pin and CN pin.
20	NC	No Connect

#### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	I	Parameter	Min.	Max.	Unit
V <sub>VIN</sub>	VIN Pin Input Voltage			20	V
$V_{BLD}$	BLD Pin Input Voltage			20	V
V <sub>OVP</sub>	OVP Pin Input Voltage			20	V
V <sub>SFB</sub>	SFB Pin Input Voltage		-0.3	20	V
$V_{IREF}$	IREF Pin Input Voltage		-0.3	6.0	V
$V_{VREF}$	VREF Pin Input Voltage		-0.3	6.0	V
V <sub>COMR</sub>	COMR Pin Input Voltage		-0.3	6.0	V
V <sub>CSP</sub>	CSP Pin Input Voltage		-0.3	6.0	V
V <sub>CSN</sub>	CSN Pin Input Voltage		-0.3	6.0	V
$V_{DP}$	DP Pin Input Voltage		-0.3	6.0	V
$V_{DN}$	DN Pin Input Voltage		-0.3	6.0	V
$V_{QN}$	QN Pin Input Voltage		-0.3	6.0	V
$V_{QP}$	QP Pin Input Voltage		-0.3	6.0	V
$V_{DD}$	VDD Pin Input Voltage		-0.3	6.0	V
V <sub>CP</sub>	CP Pin Input Voltage		-0.3	6.0	V
V <sub>CN</sub>	CN Pin Input Voltage		-0.3	6.0	V
P <sub>D</sub>	Power Dissipation (T <sub>A</sub> =25°C)			0.88	W
$\theta_{JA}$	Thermal Resistance (Junction-to-A	ir)		110	°C/W
TJ	Junction Temperature		-40	+150	°C
T <sub>STG</sub>	Storage Temperature Range		-40	+150	°C
TL	Lead Temperature, (Wave Soldering or IR, 10 Seconds)			+260	°C
		Human Body Model, JEDEC:JESD22_A114		2.0	
ESD	Electrostatic Discharge Capability	Charged Device Model, JEDEC:JESD22_C101		2.0	kV

#### Note:

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
TJ	Junction Temperature	-40	+125	°C
$V_{\text{DD-OP}}$	VDD Operating Voltage	3.12	6.00	V
V <sub>IN-OP</sub>	VIN Operating Voltage		16	V

<sup>1.</sup> All voltage values, except differential voltages, are given with respect to GND pin.

Recommended operating conditions, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
VIN Section						•
I <sub>IN-OP-LV</sub>	Operating Supply Current at 5 V (5 V, 4.8 V, 4.6 V, 4.4 V, 4.2 V, 4 V)	V <sub>IN</sub> =5 V, V <sub>CSP</sub> =100 mV, V <sub>CSN</sub> =0V		2.4	3.2	mA
I <sub>IN-OP-HV</sub>	Operating Supply Current Over 5 V (7 V, 9 V, 12 V)	V <sub>IN</sub> =12 V, V <sub>CSP</sub> =100 mV, V <sub>CSN</sub> =0 V		1.2	2.0	mA
I <sub>IN-Green</sub>	Green Mode Operating Supply Current	V <sub>IN</sub> =5 V, V <sub>CSP</sub> =V <sub>CSN</sub> =0 V		850	1050	μA
I <sub>IN-ST</sub>	Startup Current	V <sub>IN</sub> =1 V, V <sub>CSP</sub> =100 mV, V <sub>CSN</sub> =0 V			15	μΑ
V <sub>IN-UVP-L-LV</sub>	VIN Under-Voltage-Protection Enable Voltage under 5 V		2.35	2.50	2.65	V
V <sub>IN-UVP-H-LV</sub>	VIN Under-Voltage-Protection Disable Voltage under 5 V		2.85	3.00	3.15	V
V <sub>IN-UVP-L-7V</sub>	VIN Under-Voltage-Protection Enable Voltage at 7 V		5.05	5.25	5.45	V
V <sub>IN-UVP-H-7V</sub>	VIN Under-Voltage-Protection Disable Voltage at 7 V		5.75	5.95	6.15	V
V <sub>IN-UVP-L-9V</sub>	VIN Under-Voltage-Protection Enable Voltage at 9 V		6.50	6.75	7.00	V
V <sub>IN-UVP-H-9V</sub>	VIN Under-Voltage-Protection Disable Voltage at 9 V		7.40	7.65	7.90	V
V <sub>IN-UVP-L-12V</sub>	VIN Under-Voltage-Protection Enable Voltage at 12 V		8.70	9.00	9.30	V
V <sub>IN-UVP-H-12V</sub>	VIN Under-Voltage-Protection Disable Voltage at 12 V		9.85	10.20	10.55	V
t <sub>D-VIN-UVP</sub>	VIN Under-Voltage-Protection Debounce Time		10	15	20	ms
V <sub>IN-EN-L</sub>	Charge-Pump Enable Threshold Voltage		1.5	2.0	2.5	V
V <sub>IN-CP</sub>	Charge Pump Disable Threshold Voltage		6.20	6.40	6.60	V
V <sub>IN-CP-Hys</sub>	Hysteresis Voltage for Charge Pump Disable Threshold Voltage			0.20		V
V <sub>IN-OVP-LV</sub>	VIN Over-Voltage-Protection Voltage under 5 V		5.80	6.00	6.20	V
V <sub>IN-OVP-7V</sub>	VIN Over-Voltage-Protection Voltage at 7 V		8.10	8.40	8.70	V
V <sub>IN-OVP-9V</sub>	VIN Over-Voltage-Protection Voltage at 9 V		10.50	10.80	11.10	V
V <sub>IN-OVP-12V</sub>	VIN Over-Voltage-Protection Voltage at 12 V		14.00	14.40	14.80	V
t <sub>D-VIN-OVP</sub>	VIN Over-Voltage-Protection Debounce Time		16	28	40	μs
VDD Section						
$V_{\text{DD-ON}}$	Turn-on Threshold Voltage		3.50	3.65	3.80	V
$V_{DD\text{-}OFF}$	Turn-off Threshold Voltage		3.12	3.25	3.38	V
f <sub>S-CP</sub>	Charge Pump Switching Frequency <sup>(2)</sup>		120	125	130	kHz

Continued on the following page...

Recommended operating conditions, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
CC Mode Selection Section							
QP/QN- <sub>VR</sub>	QP/QN State for Variable CC Mode		(	QP=0 ar	nd QN=0	)	
QP/QN-FIX-1.5A	QP/QN State for Fixative 1.5 A CC Mode		(	QP=0 ar	nd QN=1		
QP/QN- <sub>FIX-2.0A</sub>	QP/QN State for Fixative 2.0 A CC Mode		(	QP=1 ar	nd QN=0	)	
QP/QN- <sub>CLPM</sub>	QP/QN State for Current Limit Protection Mode		(	QP=1 ar	nd QN=1		
t <sub>D_Mode</sub>	CC Mode Selection De-bounce Time		3.5	4.0	4.5	ms	
Constant Curre	ent Sensing Section			•			
A <sub>V-CCR</sub>	Output Current Sensing Amplifier Gain (3)		9.7	10.0	10.3	V/V	
V <sub>CCR-VR-5V</sub>	Reference Voltage for Constant Current Regulation at Variable CC 5 V Mode		1.155	1.200	1.245	V	
V <sub>CCR-VR-7V</sub>	Reference Voltage for Constant Current Regulation at Variable CC 7 V Mode		1.005	1.050	1.095	V	
V <sub>CCR-VR-9V</sub>	Reference Voltage for Constant Current Regulation at Variable CC 9 V Mode		0.920	0.960	1.000	V	
V <sub>CCR-VR-12V</sub>	Reference Voltage for Constant Current Regulation at Variable CC 12 V Mode		0.685	0.715	0.745	V	
V <sub>CCR-FIX-1.5A</sub>	Reference Voltage for Constant Current Regulation at Fixative 1.5 A CC Mode		0.835	0.870	0.905	V	
V <sub>CCR-FIX-1.5A-12V</sub>	Reference Voltage for Constant Current Regulation at Fixative 1.5 A CC 12 V Mode		0.635	0.660	0.685	V	
V <sub>CCR-FIX-2.0A</sub>	Reference Voltage for Constant Current Regulation at Fixative 2.0 A CC Mode		1.155	1.200	1.245	V	
V <sub>CCR-FIX-2.0A-12V</sub>	Reference Voltage for Constant Current Regulation at Fixative 2.0 A CC 12 V Mode		0.865	0.900	0.935	V	
Av-CCR-Protection	Constant Current Attenuator for Current Limit Protection Mode				0.125	V/V	
A <sub>V-CCR-UVP</sub>	Constant Current Attenuator for V <sub>IN</sub> Under-Voltage Protection				0.125	V/V	
V <sub>Green-H</sub>	Green Mode Disable Threshold Voltage		0.400	0.495	0.590	V	
V <sub>Green-L</sub>	Green Mode Enable Threshold Voltage		0.34	0.37	0.40	V	
t <sub>Green-BLANK</sub>	Green Mode Blanking Time at Startup <sup>(3)</sup>			40		ms	

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Recommended operating conditions, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Constant Vol	tage Sensing Section		· I	I	I	I
V <sub>CVR-4V</sub>	Reference Voltage for Constant Voltage Regulation at 4 V		0.770	0.800	0.830	V
V <sub>CVR-4.2V</sub>	Reference Voltage for Constant Voltage Regulation at 4.2 V		0.810	0.840	0.870	V
V <sub>CVR-4.4V</sub>	Reference Voltage for Constant Voltage Regulation at 4.4 V		0.850	0.880	0.910	V
V <sub>CVR-4.6V</sub>	Reference Voltage for Constant Voltage Regulation at 4.6 V		0.890	0.920	0.950	V
V <sub>CVR-4.8V</sub>	Reference Voltage for Constant Voltage Regulation at 4.8 V		0.930	0.960	0.990	V
V <sub>CVR-5V</sub>	Reference Voltage for Constant Voltage Regulation at 5 V		0.980	1.000	1.020	V
V <sub>CVR-7V</sub>	Reference Voltage for Constant Voltage Regulation at 7 V		1.375	1.400	1.425	V
V <sub>CVR-9V</sub>	Reference Voltage for Constant Voltage Regulation at 9 V		1.765	1.800	1.835	V
V <sub>CVR-12V</sub>	Reference Voltage for Constant Voltage Regulation at 12 V		2.355	2.400	2.445	V
Cable Drop C	ompensation Section					
K <sub>COMR-CDC</sub>	Design Parameter for Cable-Drop Voltage Compensation		0.90	1.00	1.10	μA/V
Constant Cur	rent Amplifier Section					
G <sub>m-CC</sub>	CC Amplifier Transconductance <sup>(3)</sup>			3.5		S
f <sub>P-CC</sub>	CC Amplifier Dominate Pole <sup>(3)</sup>			10		kHz
R <sub>CC-IN-CC</sub>	CC Amplifier Input Resistor <sup>(3)</sup>		8.50	13.75	19.00	kΩ
Constant Vol	tage Amplifier Section		•	ı		ı
G <sub>m-CV</sub>	CV Amplifier Transconductance <sup>(3)</sup>			3.5		S
f <sub>P-CV</sub>	CV Amplifier Dominate Pole <sup>(3)</sup>			10		kHz
I <sub>Bias-IN-CV</sub>	CV Amplifier Input Bias Current <sup>(3)</sup>				30	nA
Output Bleed	er Section			I		I
I <sub>BLD</sub>	Output Bleeder Current <sup>(3)</sup>		100		700	mA
t <sub>BLD</sub>	Output Bleeder Current Discharging Time		290	320	350	ms
	ide Feedback Section		•		ı	
I <sub>SFB-Sink-MAX</sub>	Maximum SFB Pin Sink Current <sup>(3)</sup>		2			mA
OVP Section			1	1		
I <sub>OVP-Sink-MAX</sub>	Maximum OVP Pin Sink Current		2			mA

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Recommended operating conditions, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
FCP-Single P	FCP-Single Protocol Section						
$V_{DPL}$	DP Low Threshold Voltage	BC1.2 Detection	0.23	0.25	0.27	V	
$V_{DNL}$	DN Low Threshold Voltage	BC1.2 Detection	0.30	0.35	0.40	V	
t <sub>BC1.2</sub>	DP/DN High Debounce Time		1.0		1.5	S	
R <sub>DP</sub>	DP Resistance		300	500	700	kΩ	
R <sub>DN</sub>	DN Pull-Low Resistance		14.25	19.53	24.80	kΩ	
t <sub>TOGGLE</sub>	DN Low Debounce Time after BC1.2 Detection				1	ms	
$V_{DN\_HI}$	DN High Threshold Voltage <sup>(3)</sup>		1			V	
$V_{DN\_LO}$	DN Low Threshold Voltage <sup>(3)</sup>				0.5	V	
T <sub>DN_FLT</sub>	DN Detection Debounce Time <sup>(3)</sup>			50		μs	
T <sub>START</sub>	Minimum Low in the Beginning of Control Signal		20			ms	
T <sub>5V_LS</sub>	Low-Speed Mode - Period for Voltage Reset to 5 V		8	10	12	ms	
T <sub>SV+_LS</sub>	Low-Speed Mode - Period for Voltage Increase		13.3	15.3	17.3	ms	
T <sub>5V_HS</sub>	High-Speed Mode - Period for Voltage Reset to 5 V		77	102	127	μs	
T <sub>SV+_HS</sub>	High-Speed Mode - Period for Voltage Increase		157	182	206	μs	
Pump Expres	s Protocol Section						
t <sub>ON_CCA</sub>	Current Control Pattern Timing On Time (A) <sup>(3)</sup>		410	500	600	ms	
t <sub>ON_CCB</sub>	Current Control Pattern Timing On Time (B) <sup>(3)</sup>		220	300	370	ms	
t <sub>ON_CCC</sub>	Current Control Pattern Timing On Time (C) <sup>(3)</sup>		50	100	150	ms	
t <sub>ON_CCD</sub>	Current Control Pattern Timing Off Time (D) <sup>(3)</sup>		50	100	150	ms	
V <sub>REF_H_PE</sub>	Current Sense High Threshold Voltage <sup>(3)</sup>	Max. Current Control Low Current is 130 mA and Min. Current Control High Current is 350 mA	9.3	13.3	17.3	mV	
V <sub>REF_Hys</sub>	Hysteresis for Current Sense Low signal Detection <sup>(3)</sup>			2		mV	
$T_{WDT}$	Current Plug-Out Detection Debounce Time <sup>(3)</sup>		180		240	ms	

#### Notes:

- 2. Guaranteed for temperature range -5°C ~85°C.
- 3. Guaranteed by design.

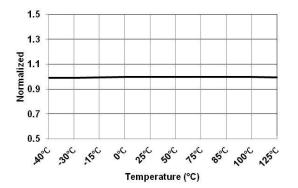


Figure 5.V<sub>DD</sub> Turn-On Threshold Voltage (V<sub>DD-ON</sub>) vs. Temperature

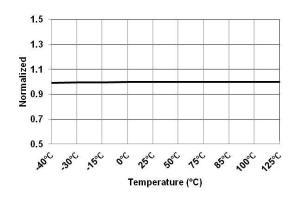


Figure 6.V $_{DD}$  Turn-Off Threshold Voltage (V $_{DD\text{-}OFF}$ ) vs. Temperature

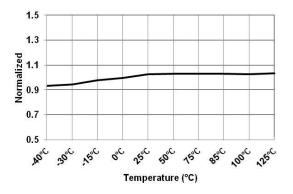


Figure 7. Operating Current Under 5 V (I<sub>IN-OP-LV</sub>) vs. Temperature

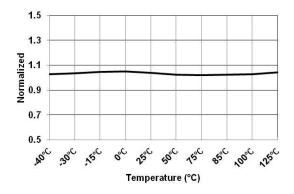


Figure 8. Operating Current Over 5 V (I<sub>IN-OP-HV</sub>) vs. Temperature

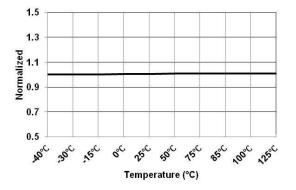


Figure 9. Reference Voltage for CC Regulation at Variable CC 5 V Mode (V<sub>CCR-VR-5V</sub>) vs. Temperature

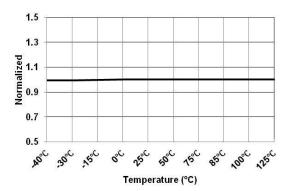
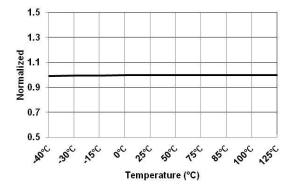


Figure 10. Reference Voltage for CC Regulation at Variable CC 7V Mode (V<sub>CCR-VR-7V</sub>) vs. Temperature



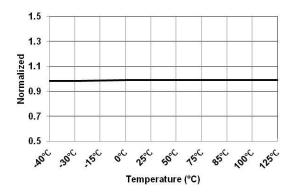
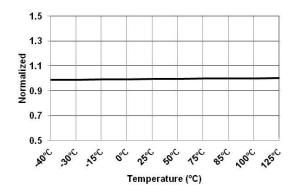


Figure 11. Reference Voltage for CC Regulation at Variable CC 9 V Mode (V<sub>CCR-VR-9V</sub>) vs. Temperature

Figure 12. Reference Voltage for CC Regulation at Variable CC 12 V Mode (V<sub>CCR-VR-12V</sub>) vs. Temperature



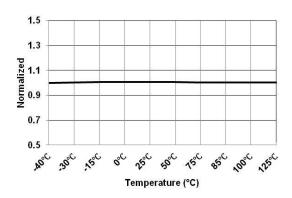
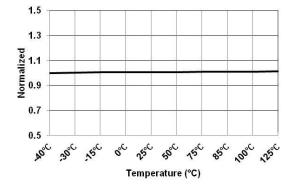


Figure 13. Reference Voltage for CC Regulation at Fixative 1.5 A CC Mode (V<sub>CCR-FIX-1.5A</sub>) vs. Temperature

Figure 14. Reference Voltage for CC Regulation at Fixative 1.5 A CC 12 V Mode (V<sub>CCR-FIX-1.5A-12V</sub>) vs. Temperature



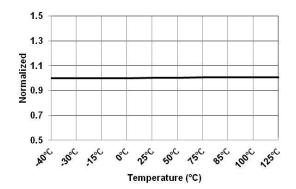
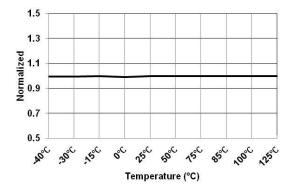


Figure 15. Reference Voltage for CC Regulation at Fixative 2.0 A CC Mode (V<sub>CCR-FIX-2.0A</sub>) vs. Temperature

Figure 16. Reference Voltage for CC Regulation at Fixative 2.0 A CC 12 V Mode (V<sub>CCR-FIX-2.0A-12V</sub>) vs. Temperature



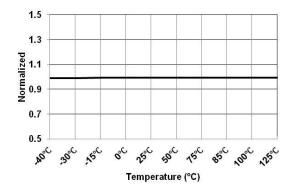
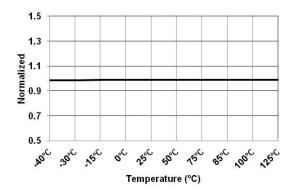


Figure 17. Reference Voltage for CV Regulation at 4 V (V<sub>CVR-4V</sub>) vs. Temperature

Figure 18. Reference Voltage for CV Regulation at 4.2 V (V<sub>CVR-4.2V</sub>) vs. Temperature



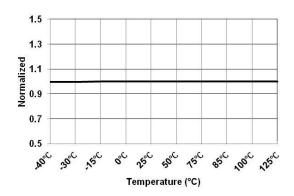
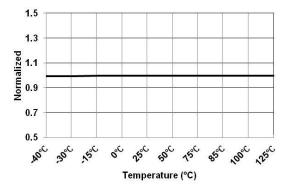
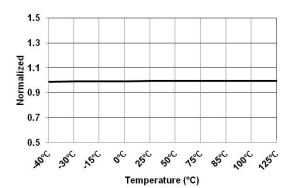


Figure 19.Reference Voltage for CV Regulation at 4.4 V (V<sub>CVR-4.4V</sub>) vs. Temperature

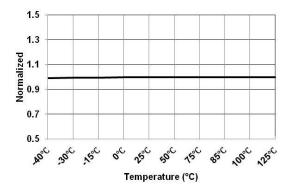
Figure 20. Reference Voltage for CV Regulation at 4.6 V (V<sub>CVR-4.6V</sub>) vs. Temperature





4.8 V (V<sub>CVR-4.8V</sub>) vs. Temperature

Figure 21. Reference Voltage for CV Regulation at Figure 22. Reference Voltage for CV Regulation at 5 V (V<sub>CVR-5V</sub>) vs. Temperature



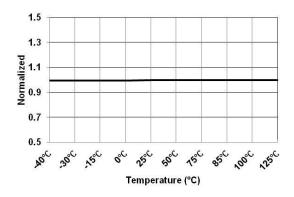
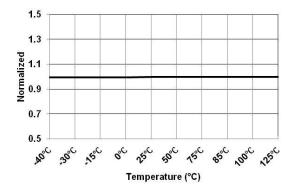


Figure 23. Reference Voltage for CV Regulation at 7 V ( $V_{\text{CVR-7V}}$ ) vs. Temperature

Figure 24. Reference Voltage for CV Regulation at 9 V (V<sub>CVR-9V</sub>) vs. Temperature



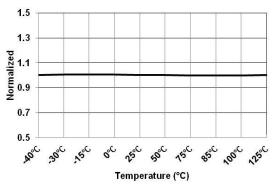
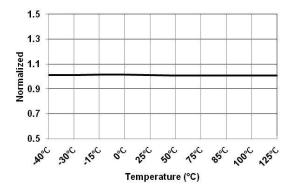


Figure 25.Reference Voltage for CV Regulation at 12 V (V<sub>CVR-12V</sub>) vs. Temperature

Figure 26. V<sub>IN</sub> OVP Voltage Under 5 V (V<sub>IN-OVP-LV</sub>) vs. Temperature



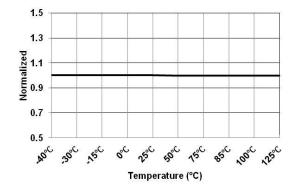
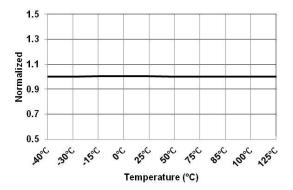


Figure 27. V<sub>IN</sub> OVP Voltage at 7 V (V<sub>IN-OVP-7V</sub>) vs. Temperature

Figure 28. V<sub>IN</sub> OVP Voltage at 9 V (V<sub>IN-OVP-9V</sub>) vs. Temperature



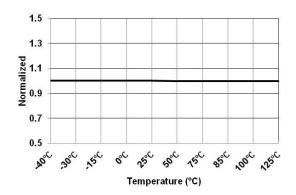
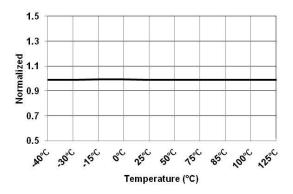


Figure 29. V<sub>IN</sub> UVP Disable Voltage at 9 V (V<sub>IN-UVP-H-9V</sub>) vs. Temperature

Figure 30. V<sub>IN</sub> UVP Enable Voltage at 12 V (V<sub>IN-UVP-L-12V</sub>) vs. Temperature



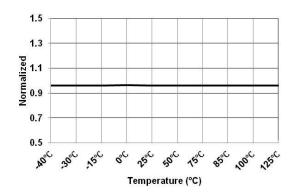
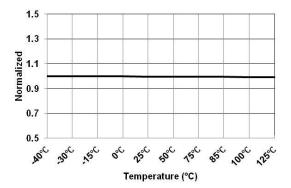


Figure 31.V<sub>IN</sub> UVP Disable Voltage at 12 V (V<sub>IN-UVP-H-12V</sub>) vs. Temperature

Figure 32. Charge Pump Disable Threshold Voltage (V<sub>IN-CP</sub>) vs. Temperature



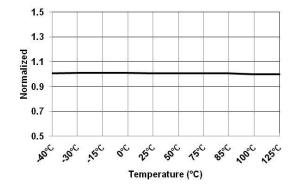


Figure 33. DP Low Level Threshold Voltage (V<sub>DPL</sub>) vs. Temperature

Figure 34. DN Low Level Threshold Voltage (V<sub>DNL</sub>) vs. Temperature

#### **Functional Description**

The highly integrated secondary-side power Constant Voltage and Constant Current Controller FAN6100M is compatible with MediaTek Pump Express<sup>TM</sup> Plus fast-Fairchild's FCP-Single charging and own communication protocol for quick charger applications. It can be an optimal solution for quick charger requirement. The FAN6100M enables power supply's output voltage adjustment if it detects a protocol capable mobile phone and/ or tablet. When a compliant powered device is detected, the FAN6100M will produce BC1.2 procedure then will be ready to acknowledge which protocol comes in. At that moment Output voltage is generated to 5 V as default and then changes to 7 V, 9 V or 12 V to meet quick charger requirements of HVDCP power supplies. These voltages are based on the capabilities of the downstream device. The downstream device requests an output voltage for the HVDCP power supply. If a non compliant powered device is detected, the controller disables adaptive output voltage to ensure safe operation with smart phones and tablets that support only 5 V.

The controller consists of two operational amplifiers for constant voltage (CV) and constant current (CC) regulation with adjustable references voltage. The CC control loop also incorporates a current sense amplifier with a gain of 10. Outputs of the CV and CC amplifiers are tied together in open drain configuration. FAN6100M also incorporates an internal charge pump circuit to maintain CC regulation down to the power supply's output voltage, Vbus of 2 V without an external voltage supply to the IC. Programmable cable voltage drop compensation allows precise CV regulation at the end of USB cable via adjusting one external resistor.

Protection functions of the FAN6100M include adaptive  $V_{IN}$  Over-Voltage Protection ( $V_{IN}$  OVP) and adaptive  $V_{IN}$  Under-Voltage Protection ( $V_{IN}$  UVP).

#### **Constant-Voltage Regulation Operation**

Figure 35 shows the primary-side internal PWM control circuit of the FAN501A and secondary side regulator circuit of the FAN6100M which consists of two operational amplifiers for constant voltage (CV) and constant current (CC) regulation with adjustable voltage references.

The constant voltage (CV) regulation is implemented in the same way as the conventional isolated power supply. Output voltage is sensed on the VREF pin via the resistor divider,  $R_{\text{F1}}$  and  $R_{\text{F2}}$  and compared with the internal reference voltage for constant voltage regulation (V\_{CVR}) to generate a CV compensation signal (COMV) on the SFB pin. The compensation signal is transferred to the primary-side using an opto-coupler and applied to the PWM comparator through attenuator Av to determine the duty cycle.

#### **Constant-Current Regulation Operation**

The constant current (CC) regulation is implemented with sensing the output current. The output current is sensed via the current-sense resistor (R<sub>CS</sub>) connected between the CSP and CSN pins and placed on the output ground return path. The sensed signal is amplified by internal current sensing amplifier A<sub>V-CCR</sub> before the amplified current feedback signal is fed into the positive terminal of the internal operational amplifier and compared with the internal reference voltage for constant current regulation (V<sub>CCR</sub>) to generate a CC compensation signal (COMI) on the SFB pin. The compensation signal is transferred to the primary-side using an opto-coupler to the primary-side PWM controller.

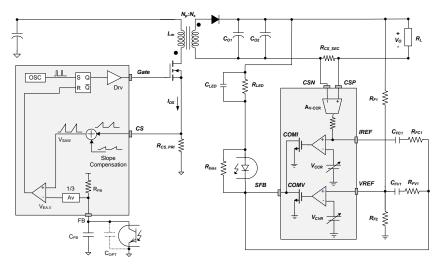


Figure 35. Internal PWM Control Circuit

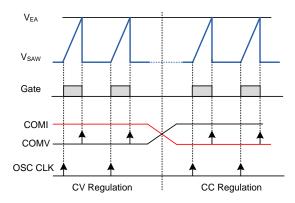


Figure 36. PWM Operation for CV and CC

 $V_{EA}$  is compared with an internal sawtooth waveform ( $V_{SAW}$ ) by PWM comparators to determine the duty cycle. As seen in Figure 35, output of the comparator is used as a reset signal of flip-flop to determine the MOSFET turn-off instant. The lower signal, either COMV or COMI, is transferred to the primary-side to determine the duty cycle, as shown in Figure 36. During CV regulation, COMV is transferred to the primary-side to determine the duty cycle while COMI is saturated to HIGH. During CC regulation, COMI is transferred to the primary-side to determine the duty cycle while COMV is saturated to HIGH.

#### **Green Mode Operation**

FAN6100M has Green Mode operation with low quiescent current consumption (< 850  $\mu$ A). During green mode, the charge pump function is disabled to reduce power consumption. The FAN6100M enters green mode when the amplified output current sensed signal is smaller than 0.37 V. If amplified output current sensed signal increases to be greater than 0.495 V, FAN6100M leaves green mode and the charge pump function is enabled.

Once FAN6100M enters green mode, the operating current is also reduced from 2.4 mA to 850  $\mu$ A to minimize power consumption. It provides low power consumption by the green mode operation at no load.

#### **Constant Current Mode Selection**

FAN6100M provides flexible output CC choice for a variety of power rating designs. The control signal is a logic level signal for constant current mode determined by QP and QN pin settings. The output constant current mode selection specifications are as follows:

**Table 1. Mode Descriptions and Settings** 

Mode Description	Mode Setting
Variable CC Mode	QP=0 and QN=0
Fixative 1.5 A CC Mode	QP=0 and QN=1
Fixative 2.0 A CC Mode	QP=1 and QN =0

For variable CC mode setting, it is variable output CC for each mode. The variable output CC for each mode specifications are as follows:

**Table 2. Variable CC Mode Specifications** 

Output Voltage	Rated Current
5 V	2.0 A
7 V	1.8 A
9 V	1.67 A
12 V	1.25 A

For fixative 1.5 A CC Mode setting, it is fixative CC output 1.5 A except for 12 V mode. The specifications are as follows:

Table 3. Fixative 1.5 A CC Mode Specifications

Output Voltage	Rated Current
4 V	
4.2 V	
4.4 V	
4.6 V	1.5 A
4.8 V	1.5 A
5 V	
7 V	
9 V	
12 V	1.1 A

For fixative 2 A CC Mode setting, it is fixative CC output 2 A except for 12 V mode. The specifications are as follows:

Table 4. Fixative 2.0 A CC Mode Specifications

Output Voltage	Rated Current
4 V	
4.2 V	
4.4 V	
4.6 V	201
4.8 V	2.0 A
5 V	
7 V	
9 V	
12 V	1.56 A

Once protection mode has occurred, the output current is adjusted and modified by  $A_{V\text{-}CCR\text{-}Protection}$ . The output current can be calculated as:

$$I_{O\_CC\_protection} \leq \frac{1}{A_{V-CCR}} \cdot \frac{V_{CCR-FIX-1.5A}}{R_{CS}} \cdot A_{V-CCR-protection} \quad \text{(1)}$$

#### **Cable Voltage Drop Compensation**

FAN6100M incorporates programmable cable voltage drop compensation function via adjusting one external resistor to maintain constant voltage regulation at the end of USB cable.

Figure 37 shows the internal block of the cable voltage drop compensation function. Output current information is obtained from the amplified current sensing voltage. Depending on the weighting of the external resistor, the current signal is modulated to offset the CV loop reference voltage,  $V_{\text{CVR}}$ . Thus, output voltage is increased by this offset voltage on the CV loop reference to compensate for cable voltage drop.

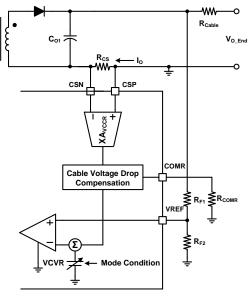


Figure 37. Cable Voltage Drop Compensation Block

#### **Supply Voltage and Charge Pump Operation**

Figure 38 shows the supply voltage circuit, including  $V_{DD}$  and the charge-pump circuit. FAN6100M can withstand up to 20 V on the VIN pin and enable this pin to be connected directly to the output terminal of a power supply.

During startup, the charge-pump circuit is enabled when  $V_{IN}$  voltage is larger than 2 V and disabled after 40 ms from the  $V_{DD}$  voltage reaches  $V_{DD\text{-}ON}$  (3.65 V). The charge-pump circuit is used to boost the  $V_{DD}$  voltage to maintain normal operation for the controller when output voltage is low. The charge-pump stage includes a low dropout (LDO) preregulator and a charge-pump circuit. The LDO preregulator regulates the input voltage of charge-pump circuit to 2.7 V and then boosts up the  $V_{DD}$  voltage when VIN is lower than  $V_{IN\text{-}CP}$  (6.4 V) and out of Green Mode. When  $V_{IN}$  is greater than the value 6.2 V which subtract  $V_{IN\text{-}CP}$  from  $V_{IN\text{-}CP\text{-}Hy\text{S}}$  or lower than  $V_{IN\text{-}CP}$  (6.4 V) in Green Mode, the charge-pump circuit is disabled and the VIN voltage is fed directly to  $V_{DD}$ .

When charge-pump circuit is disabled, output capacitor supplies charging current to charge the hold-up capacitor  $C_{VDD}$ . The  $V_{DD}$  voltage is clamped at 5.4 V by internal Zener diode when the charge-pump circuit is disabled.

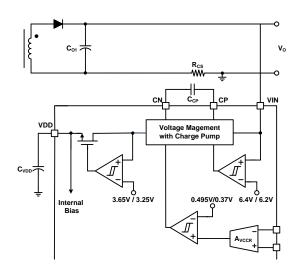


Figure 38. Supply Voltage Block

#### **Output Bleeder Section**

For HVDCP power supply applications, a discharge path on the output of the HVDCP power supply is necessary to ensure that a high output voltage level can transfer to a low output voltage level quickly during mode changes. This is especially critical under no-load condition where the natural decay rate of the output voltage is low. To enable output bleeder function when the mode changes from high output voltage to low output voltage can ensure short voltage transition time.

Figure 39 shows the internal block of output bleeder function. The FAN6100M implements the output bleeder function to discharge the output voltage rapidly during mode changes. The BLD pin is connected to the output voltage terminal as the discharging path. When the high output voltage to low output voltage mode change signal is initiated, an internal switch is turned on to discharge the output voltage. The switch stays on until  $t_{\rm BLD-MAX}$  is reached. The BLD pin can withstand up to 20 V and enable this pin to be connected directly to the output terminal of a HVDCP power supply.

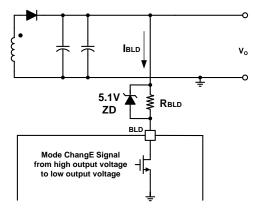


Figure 39. Output Bleeder Function

#### **VIN Over-Voltage-Protection (OVP)**

Figure 40 shows the  $V_{IN}$  over-voltage protection (OVP) block, which is adaptive operated according to mode condition. Output voltage is sensed through the VIN pin for OVP detection. Once output voltage rises to  $V_{IN-OVP}$  by each mode and then  $V_{IN}$  OVP is triggered, where  $V_{IN}$  OVP occurs, the OVP pin is pulled down to ground through an internal switch until  $V_{DD-OFF}$  (3.25 V) is reached.

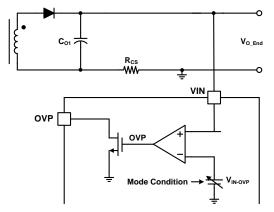


Figure 40. V<sub>IN</sub> Over-Voltage-Protection Block

#### **VIN Under-Voltage-Protection**

Figure 41 shows the  $V_{IN}$  under-voltage protection ( $V_{IN}$  UVP) block. The output current is reduced to protect the system at 5 V, 7 V, 9 V and 12 V condition when  $V_{IN}$  UVP function is triggered. Once output voltage drops below  $V_{IN-UVP-L}$ , the CC reference voltage  $V_{CCR}$  is adjusted and modified by  $A_{V-CCR-UVP}$ . The output current can be calculated as:

$$I_{O\_CC} \le \frac{1}{A_{V-CCR}} \cdot \frac{V_{CCR}}{R_{CS}} \cdot A_{V-CCR-UVP}$$
 (2)

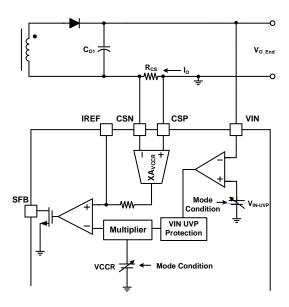


Figure 41. V<sub>IN</sub> Under-Voltage Protection Block

#### **Protocol Communication**

#### (1) MediaTek Pump Express<sup>™</sup> Plus Fast-Charging

FAN6100M is compatible with MediaTek Pump Express<sup>TM</sup> Plus fast-charging which can permit receiving output voltage change signal by CSP and CSN pin signal. There are two kinds of output current control patterns, one is for output voltage growth, and another is for output voltage reduction, shown in Figure 42 and Figure 43. FAN6100M monitors the output current control patterns by the CSP and CSN pins.

FAN6100M not only support MediaTek Pump Express<sup>TM</sup> Plus fast-charging for 5 V to 12 V quick charger application but also support for 4 V to 5 V low output voltage charger solution.

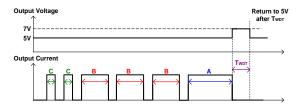


Figure 42. Output Current Control Pattern for Output Voltage Growth

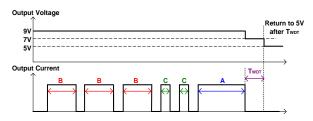


Figure 43.Output Current Control Pattern for Output Voltage Reduction

#### (2) Fairchild's own FCP-Single Communication Protocol

FAN6100M can be compatible with Fairchild's own FCP-Single communication protocol includes high-speed mode and low-speed mode to apply high-end processor and low-end processor application. For FCP-Single communication protocol detection, it uses the DN signal to determine output voltage of the HVDCP power supply. There are four types of the control signal for the output voltage adjustment, 1. Output voltage increase (SV+\_HS) for high-speed mode detection 2. Output voltage returns to 5 V (S5V\_HS) for high-speed mode detection 3. Output voltage increase (SV+\_LS) for low-speed mode detection. Figure 44 shows FCP-Single communication protocol control signal waveform.

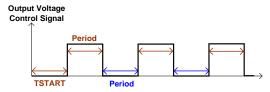


Figure 44. FCP-Single Communication Protocol Control Signal Waveform

#### **Applications Information**

#### **Constant Current Mode Selection**

For variable CC mode setting, QP and QN should be connected to ground as low level signal.

For fixative 1.5 A CC Mode setting, QP should be connected to ground as low level signal and QN can be open to generate high level signal.

For fixative 2.0 A CC Mode setting, QN should be connected to ground as low level signal and QP can be open to generate high level signal.

# **Setting Output Voltage Sensing Resistor** for VREF Pin

The output voltage can be derived by setting  $R_{\text{F1}}$  and  $R_{\text{F2}}$ , as calculated by:

$$V_O = V_{CVR} \cdot \frac{R_{F1} + R_{F2}}{R_{F2}} \tag{3}$$

Considering the low stand-by power request and the noise immunity for VREF, it is typical to select currents, which is flowing current through resistor divider, range from 100  $\mu A$  up to 250  $\mu A$  can be used.

# **Setting Secondary Side Output Constant Current Sensing Resistor**

The constant current point (I<sub>O\_CC</sub>) can be set by selecting the current sensing resistor as:

$$I_{O\_CC} = \frac{1}{A_{V-CCR}} \cdot \frac{V_{CCR}}{R_{CS}} \tag{4}$$

# Setting Capacitance for $V_{\text{DD}}$ and Charge-Pump Circuit

FAN6100M can withstand up to 20 V on the VIN pin and enable this pin to be connected directly to the output terminal of a power supply. It is typical to use a 100  $\Omega$  resistor between the VIN pin and the output terminal of a power supply and then connect 470 nF capacitor on VIN pin if ESD immunity need to be enhanced.

The charge-pump circuit needs an external capacitor,  $C_{CP}$ , typically 220 nF~1  $\mu$ F, as the energy storage element. To stabilize the operation of the clamping LDO stage, it is typical to use 1  $\mu$ F capacitor to keep the LDO loop stable. The  $C_{VDD}$  typically 220 nF~1  $\mu$ F, as the energy storage element.

#### **Select Cable Drop Compensation Resistor**

The external compensation resistor,  $R_{\text{COMR}}$ , can be calculated by:

$$R_{COMR} = \frac{R_{F2}}{R_{F1} + R_{F2}} \cdot \frac{R_{Cable}}{R_{CS}} \cdot \frac{1}{A_{V-CCR}} \cdot \frac{1}{K_{COMR-CDC}}$$
 (5)

where:

 $R_{F1}$  and  $R_{F2}$  = output feedback resistor divider

derived from Eq. (3);

 $R_{Cable}$  = cable resistance;

R<sub>CS</sub> = current sensing resistor derived from

Eq. (4);

 $K_{COMR-CDC}$  = cable compensation design parameter

of the controller, which is 1.0  $\mu$ A/V;

and

 $A_{V-CCR}$  = derived from Eq. (4), 10 V/V.

#### **Setting Bleeder Resistor**

The BLD pin can withstand up to 20 V and enable this pin to be connected directly to the output terminal of a HVDCP power supply, but the output voltage should not lower than 4.1 V at output voltage transition and short transition time consideration, it recommends adding 2 step bleeder circuits, which is one 5.1 V Zener diode and one resistance ( $R_{BLD}$ ), to avoid output voltage drop deeply.

The first step bleeder current is determined by internal constant current design, the type value is 240 mA. The second step bleeder discharging current ( $I_{BLD}$ ) can be adjusted by external bleeder series resistor ( $R_{BLD}$ ), calculated as:

$$I_{BLD} = \frac{V_O}{R_{BLD}} \tag{6}$$

where  $R_{BLD}$  is bleeder resistor connected between the output side and the BLD pin.

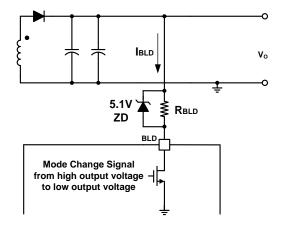


Figure 45. Output Bleeder Function

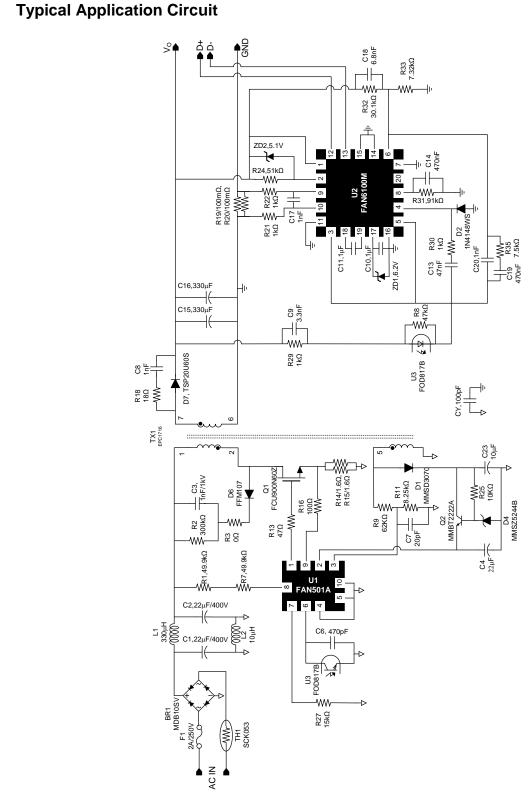


Figure 46. Schematic of Typical Application Circuit

# **Transformer Specification**

Core: EPC-1716 Bobbin: EPC-1716

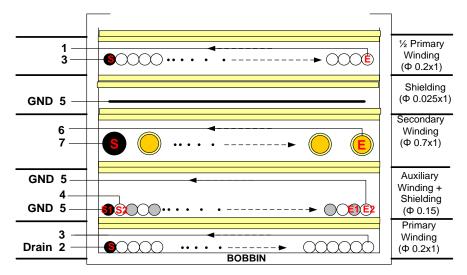
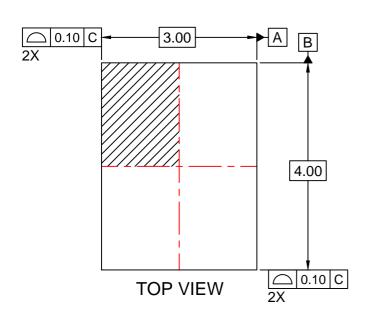
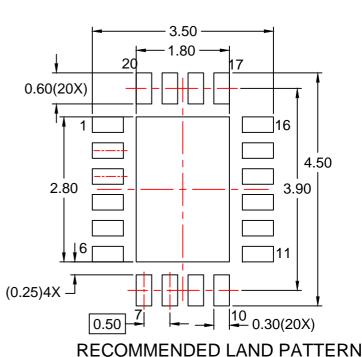


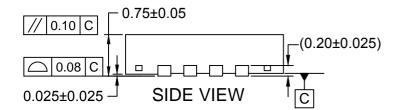
Figure 47. Transformer Diagram

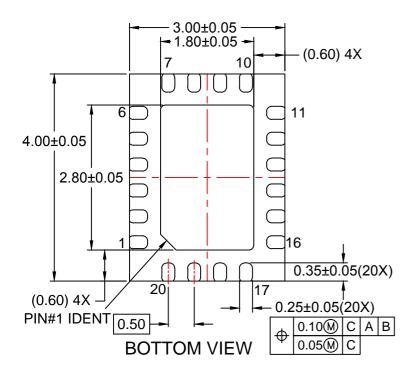
M/in din a	Terminal		NA/:	T	Isolation Layer	
Winding	Start Pin	End Pin	Wire	Turns	Turns	
NP-2	3	1	0.2 mm×1	26	2	
Copper Shielding	5	Open	Copper Foil 0.025 mm	1	2	
Ns	7	6	0.7 mm×1	6	2	
Na	4	5	0.15 mm×1	11	2	
Na-Shield	5	Open	0.15 mm×1	11	2	
NP-1	2	3	0.2 mm×1	34	2	
Bobbin – EPC1716						

Inductance	1-2	600 μH± 5%	100 kHz
Effective Leakage	1-2	<30 µH Maximum	Short Other Pin









#### NOTES:

- A. DOES NOT FULLY CONFORMS TO JEDEC REGISTRATION MO-220.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS BASED ON FSC DESIGN ONLY.
- E. DRAWING FILENAME: MKT-MLP20Drev2.
- F. FAIRCHILD SEMICONDUCTOR.



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